

MOSFET – N-Channel, UniFET™

500 V, 16.5 A, 380 mΩ

FDA16N50-F109

Description

UniFET MOSFET is onsemi's high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.

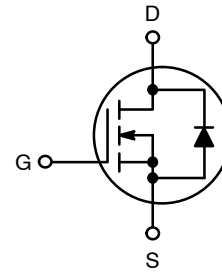
Features

- $R_{DS(on)} = 380\text{ m}\Omega$ (Max.) @ $V_{GS} = 10\text{ V}$, $I_D = 8.3\text{ A}$
- Low Gate Charge (Typ. 32 nC)
- Low C_{rss} (Typ. 20 pF)
- 100% Avalanche Tested
- This is a Pb-Free Device

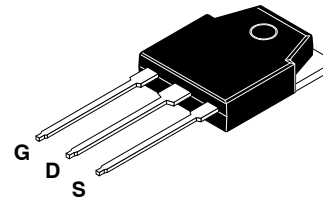
Applications

- PDP TV
- Uninterruptible Power Supply

V_{DS}	$R_{DS(on)}\text{ MAX}$	$I_D\text{ MAX}$
500 V	380 mΩ @ 10 V	16.5 A

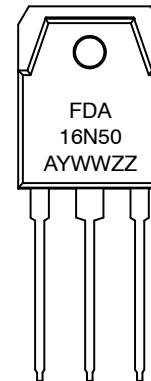


N-Channel



TO-3P-3LD
 CASE 340BZ

MARKING DIAGRAM



FDA16N50 = Specific Device Code
 A = Assembly Location
 YWW = Date Code (Year & Week)
 ZZ = Assembly Lot

ORDERING INFORMATION

Device	Package	Shipping
FDA16N50-F109	TO-3P-3LD (Pb-Free)	450 Units / Tube

FDA16N50-F109

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	FDA16N50-F109	Unit
V _{DSS}	Drain-Source Voltage	500	V
I _D	Drain Current -	-Continuous (T _C = 25°C)	16.5
		-Continuous (T _C = 100°C)	9.9
I _{DM}	Drain Current	-Pulsed (Note 1)	66
V _{GSS}	Gate-Source Voltage	±30	V
E _{AS}	Single Pulsed Avalanche Energy (Note 2)	780	mJ
I _{AR}	Avalanche Current (Note 1)	16.5	A
E _{AR}	Repetitive Avalanche Energy (Note 1)	20.5	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	4.5	V/ns
P _D	Power Dissipation	(T _C = 25°C)	205
		-Derate Above 25°C	2.1
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to +150	°C
T _L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Second	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. L = 5.1 mH, I_{AS} = 16.5 A, V_{DD} = 50 V, R_G = 25 Ω, Starting T_J = 25 °C.
3. I_{SD} ≤ 16.5 A, di/dt ≤ 200 A/μs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25 °C.

THERMAL CHARACTERISTICS

Symbol	Parameter	FDA16N50-F109	Unit
R _{θJC}	Thermal Resistance, Junction-to-Case, Max.	0.6	°C/W
R _{θJA}	Thermal Resistance, Junction-to-Ambient, Max.	40	

FDA16N50-F109

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	500	-	-	V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C	-	0.5	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 500 V, V _{GS} = 0 V	-	-	1	μA
		V _{DS} = 400 V, T _C = 125°C	-	-	10	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V	-	-	100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V	-	-	-100	nA

ON CHARACTERISTICS

V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA	3.0	-	5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 8.3 A	-	0.31	0.38	Ω
g _{FS}	Forward Transconductance	V _{DS} = 40 V, I _D = 8.3 A	-	23	-	S

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	-	1495	1945	pF
C _{oss}	Output Capacitance		-	235	310	pF
C _{rss}	Reverse Transfer Capacitance		-	20	30	pF

SWITCHING CHARACTERISTICS

t _{d(on)}	Turn-On Delay Time	V _{DD} = 250 V, I _D = 16 A, R _G = 25 Ω (Note 4)	-	40	90	ns
t _r	Turn-On Rise Time		-	150	310	ns
t _{d(off)}	Turn-Off Delay Time		-	65	140	ns
t _f	Turn-Off Fall Time		-	80	170	ns
Q _g	Total Gate Charge	V _{DS} = 400 V, I _D = 16 A, V _{GS} = 10 V (Note 4)	-	32	45	nC
Q _{gs}	Gate-Source Charge		-	8.5	-	nC
Q _{gd}	Gate-Drain Charge		-	14	-	nC

DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

I _S	Maximum Continuous Drain-Source Diode Forward Current	-	-	9.2	A	
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current	-	-	37	A	
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 16.5 A	-	-	1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 16 A, di _F /dt = 100 A/μs	-	490	-	ns
Q _{rr}	Reverse Recovery Charge		-	5.0	-	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially Independent of Operating Temperature Typical Characteristics.

TYPICAL CHARACTERISTICS

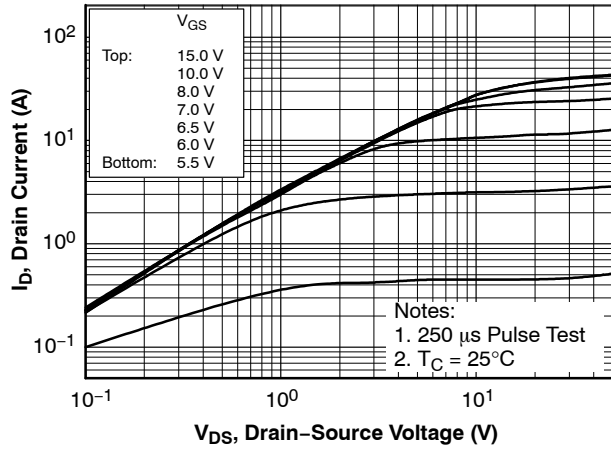


Figure 1. On-Region Characteristics

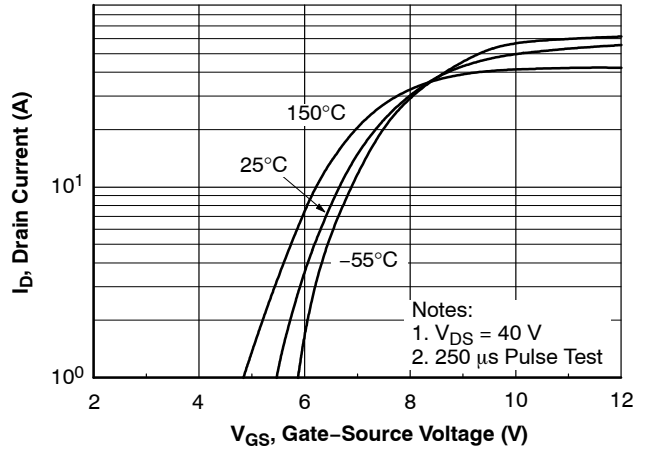


Figure 2. Transfer Characteristics

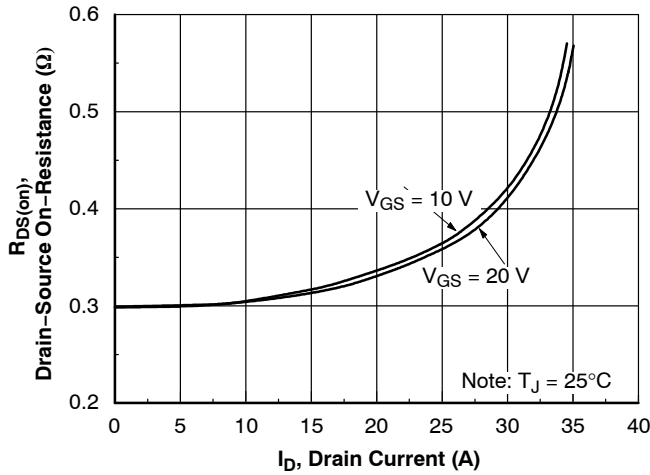


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

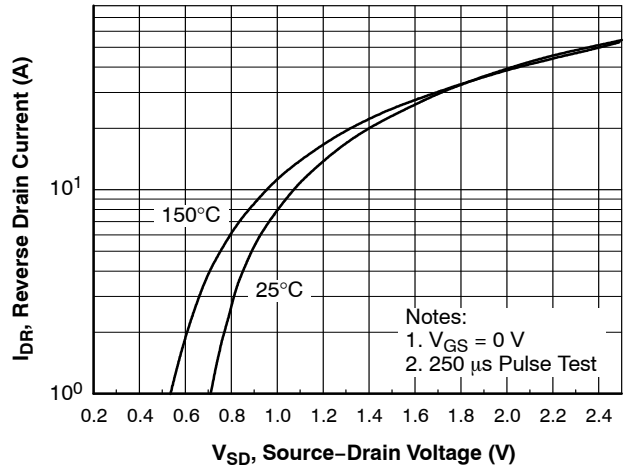


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

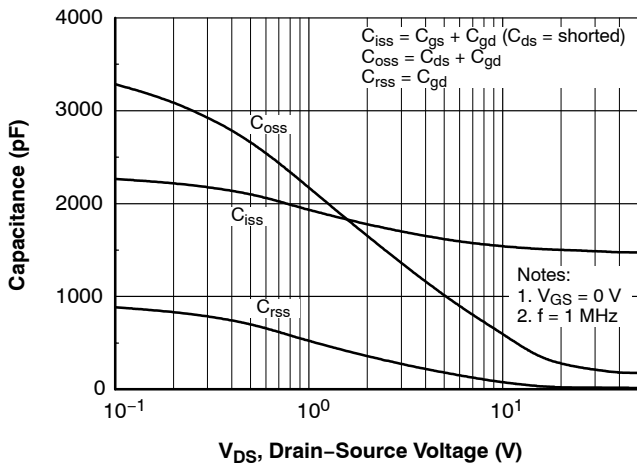


Figure 5. Capacitance Characteristics

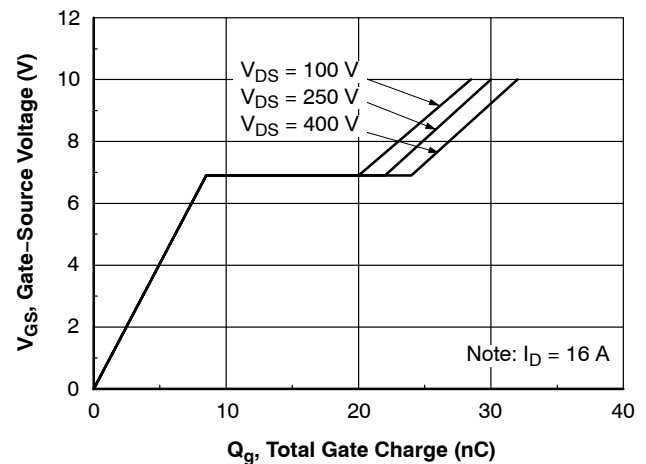


Figure 6. Gate Charge Characteristics

TYPICAL CHARACTERISTICS (Continued)

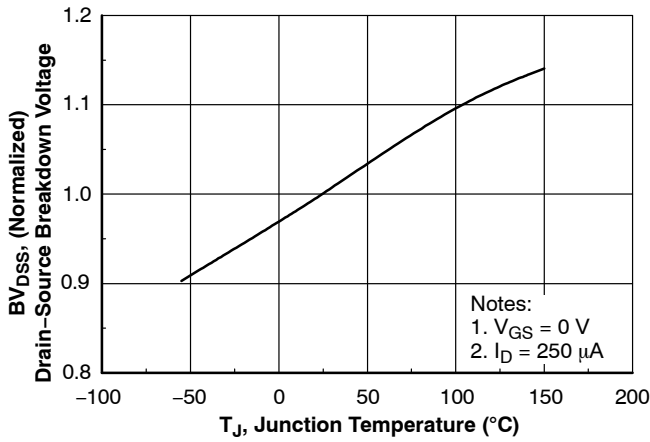


Figure 7. Breakdown Voltage Variation vs. Temperature

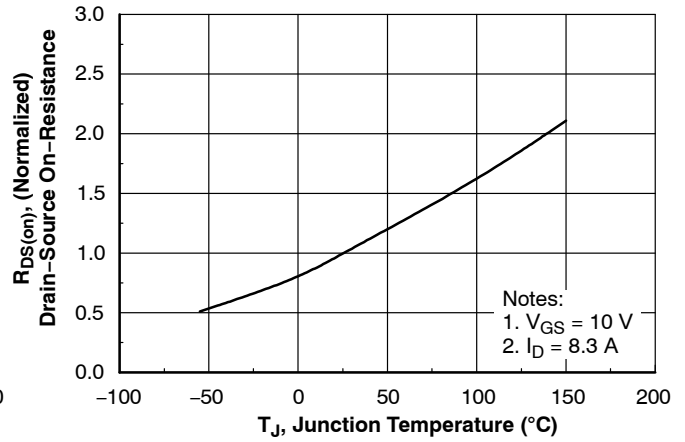


Figure 8. On-Resistance Variation vs. Temperature

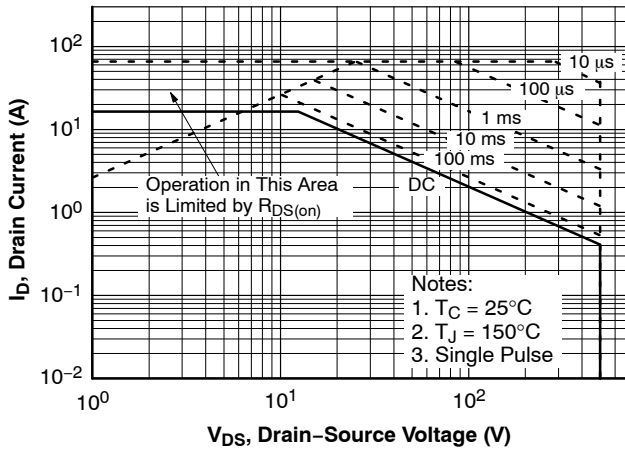


Figure 9. Maximum Safe Operating Area

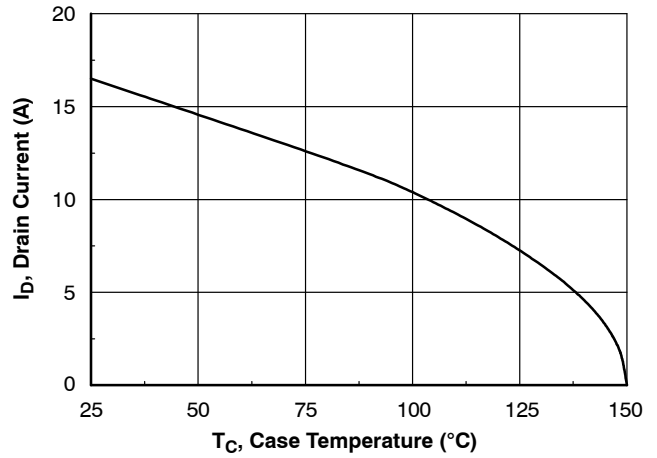


Figure 10. Maximum Drain Current vs. Case Temperature

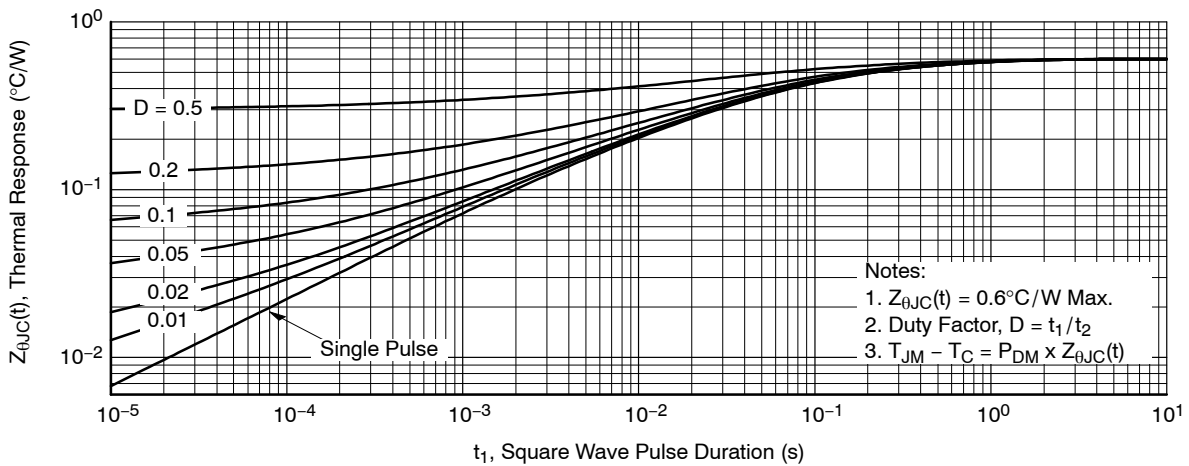


Figure 11. Transient Thermal Response Curve

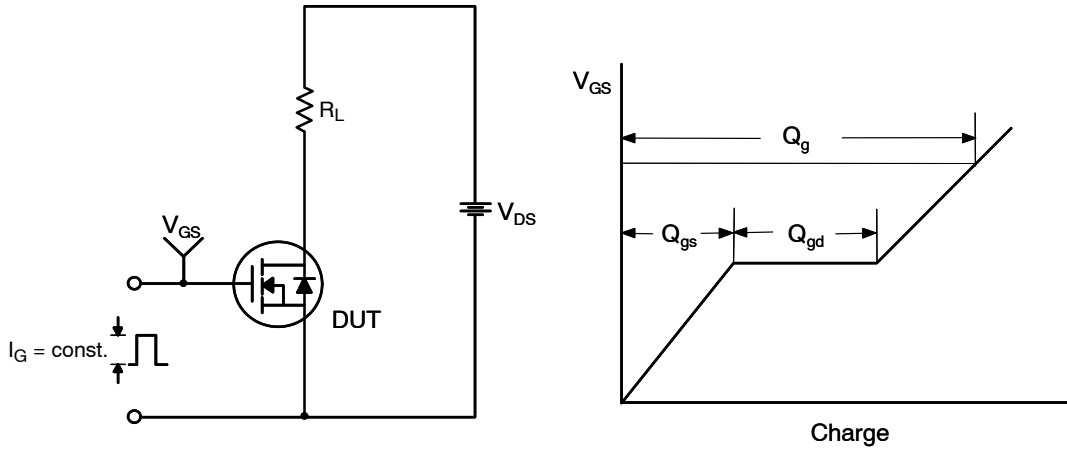


Figure 12. Gate Charge Test Circuit & Waveform

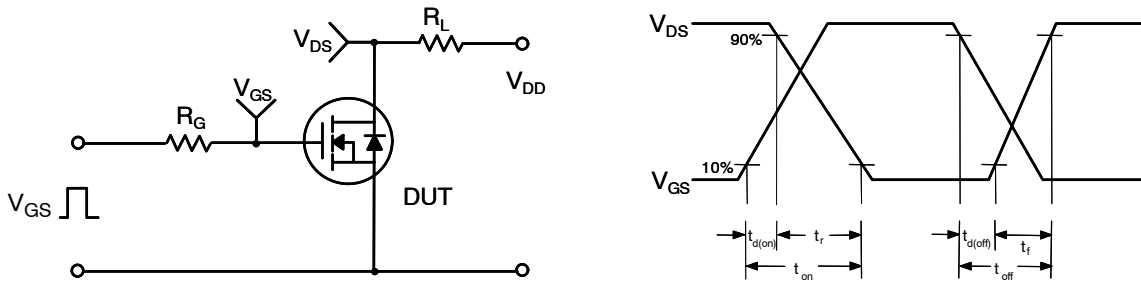


Figure 13. Resistive Switching Test Circuit & Waveforms

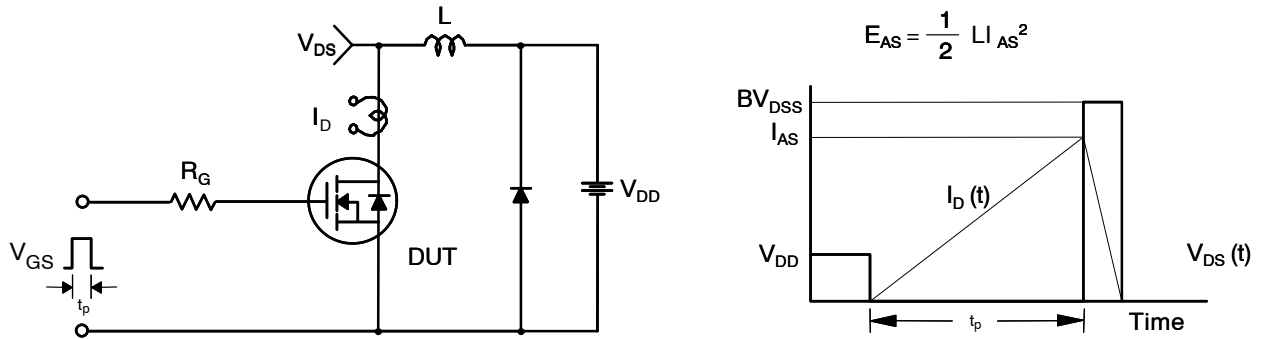


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

FDA16N50-F109

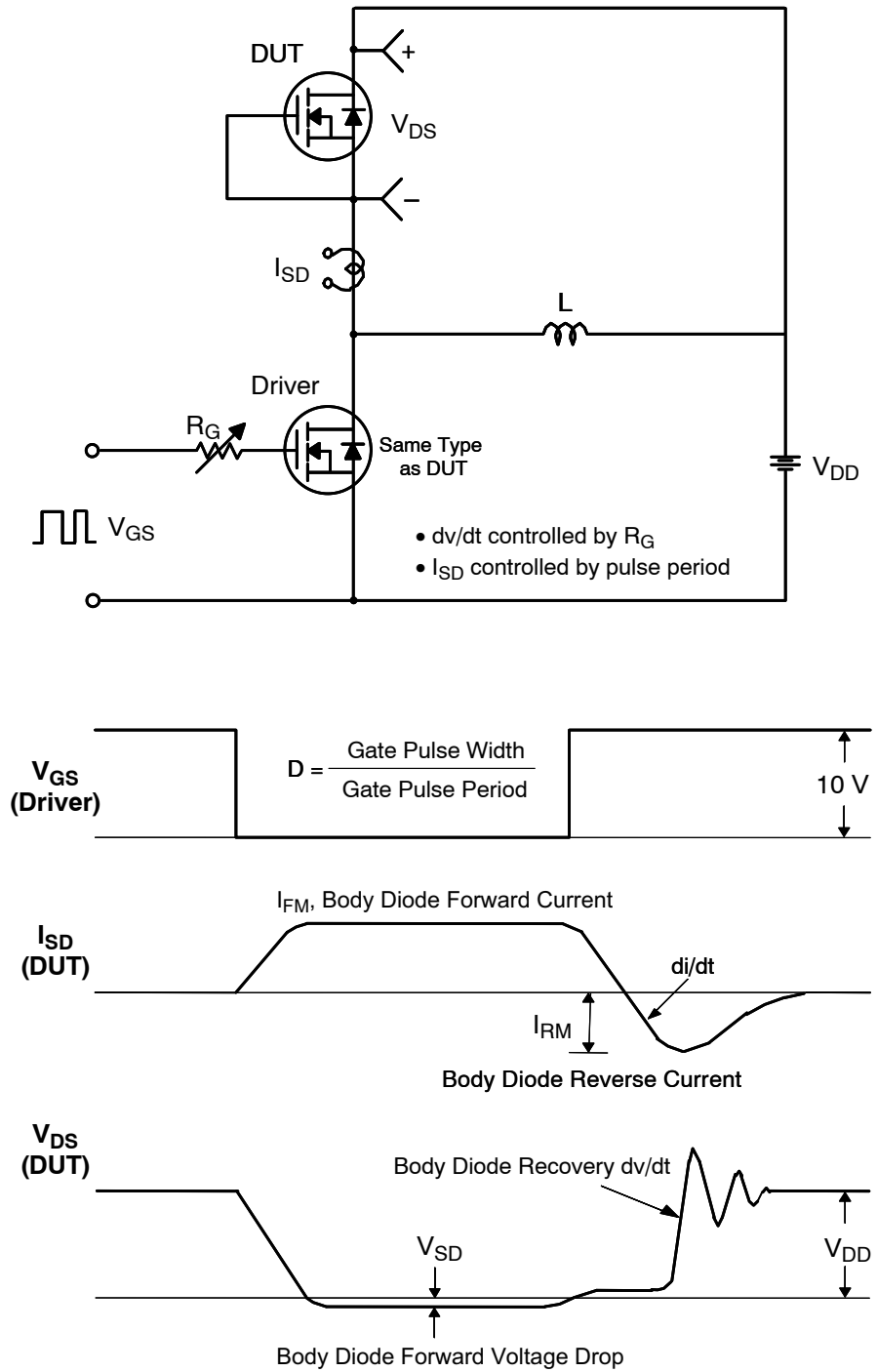
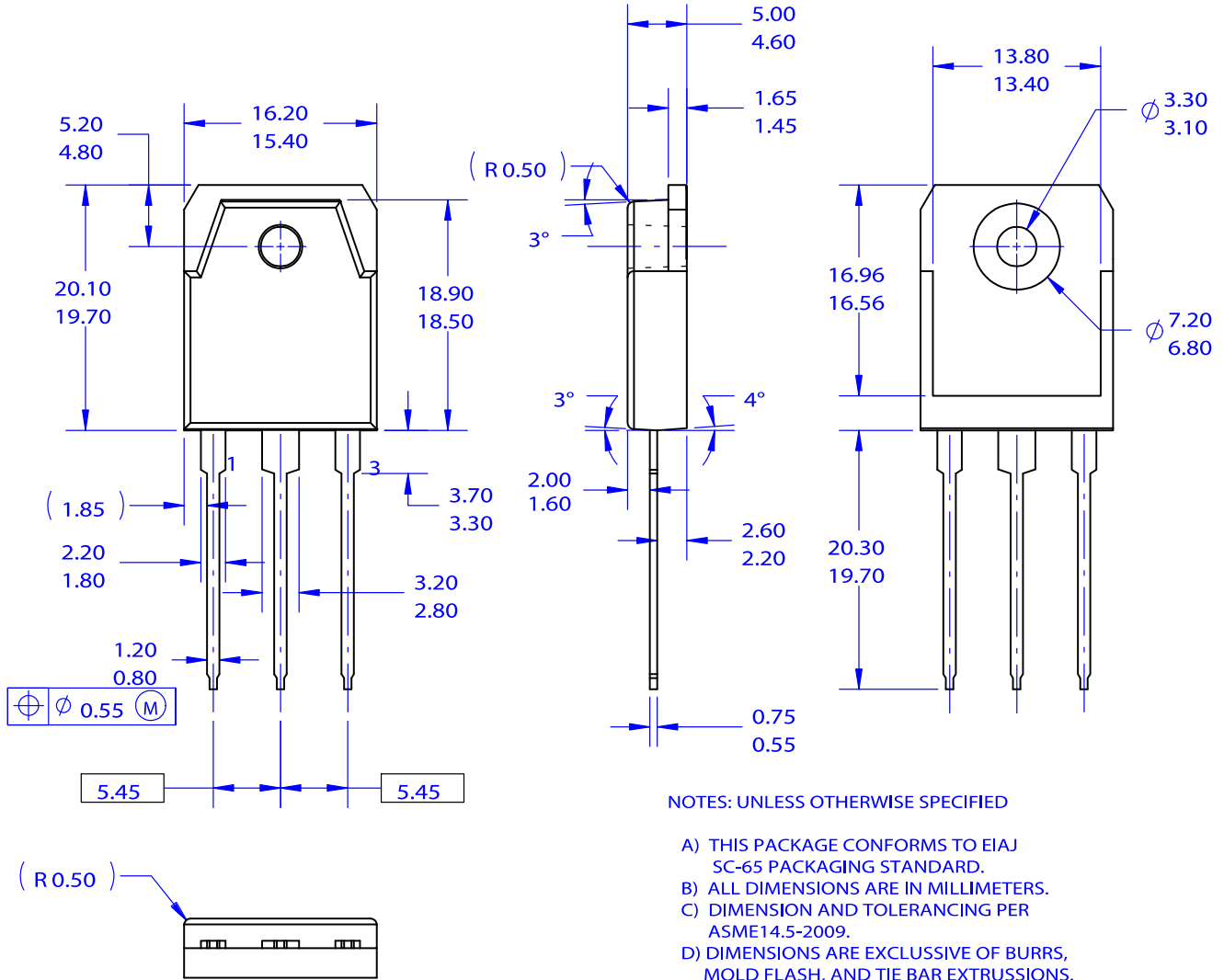


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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TO-3P-3LD / EIAJ SC-65, ISOLATED
CASE 340BZ
ISSUE O

DATE 31 OCT 2016



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